



Customer Information Notification

201403006I

Issue Date: 30-Mar-2014

Effective Date: 30-Apr-2014

Here's your personalized quality information concerning products Digi-Key purchased from NXP.
For detailed information we invite you to [view this notification online](#)



QUALITY

Management Summary

Introducing lighter reels for tape & reel packing at APB and APK.

Change Category

- | | | | |
|--|---|---|---|
| <input type="checkbox"/> Wafer Fab process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Electrical spec./Test coverage | <input type="checkbox"/> Mechanical Specification |
| <input type="checkbox"/> Wafer Fab location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Test Location | <input checked="" type="checkbox"/> Packing/Shipping/Labeling |

NXP will introduce new design lighter packing reels using less material.

Information Notification

As announced through GN 201310002 NXP will introduce a new design reels using less material. Materials used will not change.

Through this CIN NXP communicates the introduction of three reels at our assembly sites APB and APK.

These reels have been tested and fulfill our packing requirements and are in compliance with EIA-481D and IEC60286-3.

Conversion for the products in this phase will start per mid April 2014, to be finalized later in 2014. Stock of reels with current design will be used up before delivery of products in light weight reels will start. In the conversion period current and light weight reels might be mixed, but viewing the fact that they are fully compatible, this will not hamper processing at customers.

For detailed information we invite you to view this notification online (see link above) where a file is attached which indicates what the change looks like and what has been tested to release this.

Why do we issue this Information Notification

This change enables environmental improvement by reducing waste materials.

Identification of Affected Products

Products from APB and APK can be identified by the letter n and S on the third line of marking and on the packing label (if space permits).

Impact

No impact to the product's functionality anticipated. The major dimensions will not change, reels are fully compatible with the reels currently used.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Additional information

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

| | |
|-----------------------|--|
| Name | Michiel Maas Geesteranus |
| Position | Technical change coordinator |
| e-mail address | michiel.maas.geesteranus@nxp.com |

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.
Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

A global semiconductor company with operations in more than 25 countries, NXP posted unaudited revenue of \$4.36 billion in 2012.

You have received this email because you are a designated contact or subscribed to NXP's Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

[View Notification](#)

[Subscription](#)

[Support](#)

[NXP](#) | [Privacy Policy](#) | [Terms of Use](#)

NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

